

Docket No.: 3273-0208PUS1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hisashi MAESHIMA et al.

Application No.: 10/526,672

Confirmation No.: 3246

Filed: March 4, 2005

Art Unit: 1712

For: PROCESS FOR PREPARATION OF
ALICYCLIC DIEPOXY COMPOUNDS,
CURABLE EPOXY RESIN COMPOSITIONS,
EPOXY RESIN COMPOSITIONS FOR THE
ENCAPSULATION OF ELECTRONIC PARTS,
STABILIZERS FOR ELECTRICAL
INSULATING OILS, AND CASTING EPOXY
RESIN COMPOSITIONS FOR ELECTRICAL..

Examiner: R. E. Sellers

REPLY TO RESTRICTION REQUIREMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In reply to the Restriction Requirement dated October 15, 2007, the following remarks
are respectfully submitted in connection with the above-identified application.

This reply includes: Remarks.